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PATENT  
USA.292IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Assignee: 3D Systems Inc.  
U.S. Patent No.: 7011783  
Issued: 3/14/2006  
For: Cooling Techniques in Solid  
Freeform Fabrication

Customer No.: 22514

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The above-noted Assignee to this patent wishes to inform you that it wishes to change entity status of this U.S. Patent from Small Entity to Large Entity. Please make this status change in the records of the USPTO. All future fees will be paid as Large Entity.

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Dated: May 4, 2006

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Respectfully submitted,  
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